

2MHz 2A MAX Output Synchronous Step Down Converter

Features

- Soft Start
- Internal Current Limit
- High Efficiency Up to 95%
- Very Low Quiescent Current of 40uA
- MAX 2A Output Current at V_{IN}=3V
- 2MHz Constant Frequency Operation
- Internal Synchronous Rectifier Eliminates Schottky Diode
- Adjustable Output Voltages From 0.6V to V_{IN}
- Fixed Output Voltage Options Available
- 100% Duty Cycle Low-Dropout Operation
- 0.1uA Shutdown Current
- Tiny SOT23-5L Package

Applications

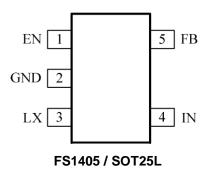
- Blue Tooth Headsets
- Portable Audio Players
- Mobile Phones
- Wireless and DSL Modems
- Digital Cameras
- Portable Instruments

General Description

The FS1405 is a fixed-frequency current-modes Synchronous PWM step down converter that is capable of delivering MAX 2A of output current while achieving peak efficiency of 95%. Under light load conditions, the FS1405 operates in a proprietary pulse skipping mode that consumes just 40uA of supply current, maximizing battery life in portable applications. The FS1405 operates with a fixed frequency of 2MHz, minimizing noise in noise-sensitive applications and allowing the use of small external components. The FS1405 is an ideal solution for applications powered by Li-lon batteries or other portable applications that require small board space.

The FS1405 is available in an adjustable output voltage version capable of generating output voltage version from 0.6V to V_{IN} . The FS1405 is available in the tiny 6-pin SOT23-5L package.

Pin Configurations



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Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
IN Pin Voltage	V _{IN}	-0.3 to 7V	V
FB Pin Voltage	V_{FB}	-0.3 to 7V	V
EN Pin Voltage	V _{EN}	-0.3 to 7V	V
SW Pin Voltage	V _{sw}	-0.3 to V _{IN} + 0.3	V
Continuous SW Current	I _{sw}	Internally limited	А
Maximum Power Dissipation (derate 5.3mW/°C above T _A =50°C)	P _D	530	mW
Operating Junction Temperature	T_{opr}	-40 to + 150	
Storage Temperature Range	T _{stg}	-55 to + 150	$^{\circ}$
Lead Temperature (Soldering, 10 seconds)	T _{solder}	300	

• Electrical Characteristics

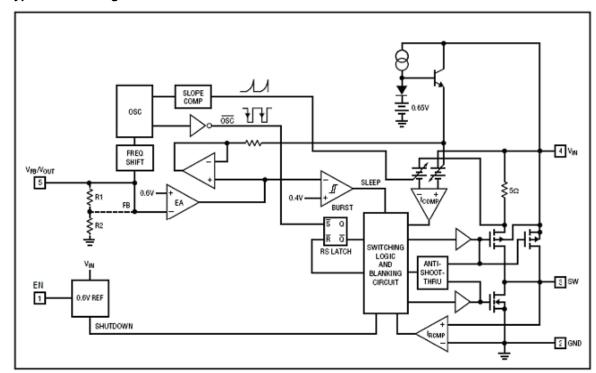
($V_{IN}=V_{EN}=3.6V$, $T_A=25^{\circ}C$ $C_{in}=4.7Uf$ $C_{out}=10uF$ all capacitors are ceramic, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Input Voltage Range	V _{IN}		2.5		6.5	V
Under Voltage Lockout Threshold	V _{UVLO}	V _{IN} rising, hysteresis =0.1V	2.25	2.4	2.5	V
Operating Supply Current		V _{FB} =60%,I _{OUT} =0		586		uA
Standby Supply Current		V _{FB} =105%,I _{OUT} =0		33	40	uA
Shutdown Supply Current		V _{EN} =0V,V _{IN} =4.2V		0.1	5	uA
		T _A =25℃	0.591	0.6	0.609	V
Adjustable Version Regulation Voltage	V_{FB}	0°C <t<sub>A<85°C</t<sub>	0.588	0.6	0.612	V
		-40℃ <t<sub>A<85℃</t<sub>	0.582	0.6	0.618	V
Output Voltage Line Regulation		V _{IN} =3V to 5V		0.016	0.4	%/V
Output Voltage Load Regulation		I _{out} =10mA to 1500mA		1		%
Inductor Current Limit	I _{LIM}	V_{IN} =3.0V, V_{FB} =90% of $V_{out(NOM)}$		2.5		Α
Oscillator Frequency	f _{SW}	V _{FB} or V _{OUT} in regulation		2		MHz
PMOS On Resistance	R _{ONP}	I _{SW} =-100mA		0.25	1	Ω
NMOS On Resistance	R _{ONN}	I _{SW} =100mA		0.23		Ω
SW Leakage Current		EN=GND,V _{IN} =5.5V V _{SW} =5.5V			1	uA
EN Logic High Threshold	V _{IH}	V _{IN} =2.7V to 5.5V	1.4			V
EN Logic Low Threshold	V _{IL}	V _{IN} =2.7V to 5.5V			0.4	V
EN Input Bias Current	I _{EN}	V _{IN} =5.5V,EN=GND or IN		0.01	0.1	uA

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• Typical Block Diagram



• Pin Description

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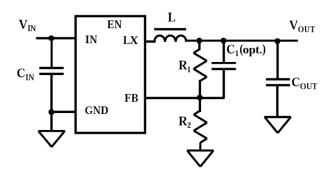
DESIGNATOR	SYMBOL	DESCRIPTION
12	Output Detection Voltage	AD=ADJ
34	Package Type:	SK: SOT23-5L

NO:	Pin Name	Pin Description
① EN		Enable Control Input. Drive EN to IN or to a logic high for normal operation, drive to GND or a
		logic low to disable the regulator.
2	GND	Ground.
3	LX	Switching Node Output. Connect this pin to the switching end of the inductor.
4	IN	Power Input. Bypass to GND as close as possible to the IC with a high quality ceramic capacitor.
		Feedback Node. For fixed output voltage options, connects this pin directly to the output. For the
5	FB	Adjustable output version the voltage at this pin is regulated to 0.6V; connect to this pin to the
		center of the output voltage feedback network.

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Application Information



Application note:

1. Inductor Value (Table 1)

Table 1. Typical Inductor Values

V _{out}	0.6V to 0.9V	0.9V to 1.8V	>1.8V
L	1.5uH	2.2uH	2.7uH

- 2, C_{in} =4.7uF(ceramic capacitor).
- 3. Cout=10uF(ceramic capacitor).
- 4. Output Voltage Programming

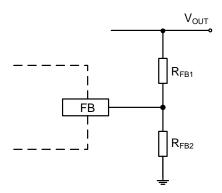


Figure 1. Output Voltage Programming

Figure 1 shows the Feedback network necessary to set the output voltage when the adjustable version is used. Select the proper ratio of the two feedback resistors $R_{_{FB1}}$ and $R_{_{FB2}}$ based on the desired output voltage. Typically choose $R_{_{FB2}} \approx 100 K\,\Omega\,$ and determine $R_{_{FB1}}$ from the output voltage:

$$R_{FB1} = R_{FB2} (\frac{V_{OUT}}{0.6V} - 1)$$

Connect a small capacitor across $R_{\mbox{\tiny FB1}}$ for feed forward capacitance at the FB pin:

$$C_{ff} = 2 \times 10^{-5} / R_{FB1}$$

where $R_{\text{\tiny FB1}}$ =900K Ω use 22pF. When using very low ESR output capacitors, such as ceramic, check for stability while examining load-transient response, and increase the compensation capacitor C_1 if needed.

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5. Dropout Operation

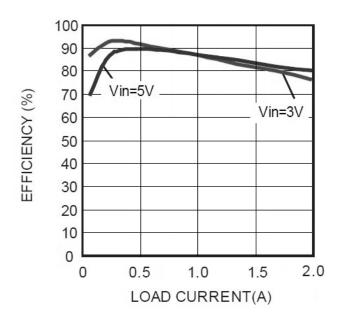
As the input supply voltage decreases to a value approaching the output voltage, the duty cycle increases toward the maximum on-time. Further reduction of the supply voltage forces the main switch to remain on for move than one cycle until it reaches 100% duty cycle. Possible occurred larger ripple on the low-dropout operation. Recommended operating voltage $V_{\text{\tiny IN}} \geqslant V_{\text{\tiny OUT}} + 0.7V$

PCB layout caution

- 1. The power traces, consisting of the GND trace, the SW trace and the Vin trace should be keep short, direct and wide.
- $2 \cdot V_{fb}$ should be connected directly to the feedback resistors, The resistive divider R1/R2 must connected between the (+) plate of C_{out} and ground.
- 3. The (+) plate of Cin should be connected to Vin as closely as possible, because this capacitor provides the AC current to the internal power MOSFETS.
- 4 Keep the switching node SW away form the sensitive V_{fb} node
- 5. Keep the (-) plates of C_{in} and C_{out} as close as possible
- 6. The high current paths
- 7. The recommended PCB layout

Typical Performance Characteristics

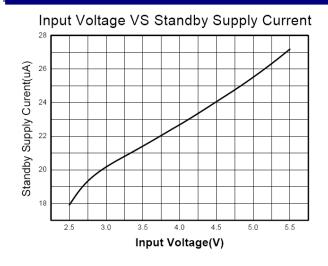
For FS1405

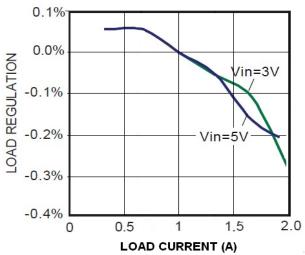






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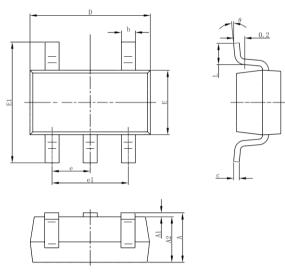






Package Information

SOT-23-5L PACKAGE OUTLINE DIMENSIONS



Symbol -	Dimensions I	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950(0.950(BSC)		BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	